

APPLICABLE STANDARD								
RATING	OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C <sup>(1)</sup>		STORAGE TEMPERATURE RANGE	-10 °C TO 60 °C <sup>(2)</sup>			
	VOLTAGE	100 V AC		STORAGE HUMIDITY RANGE	40 % TO 70 % <sup>(2)</sup>			
	CURRENT	0.5 A (SIGNAL CONTACT) <sup>(3)</sup> 3 A (MF CONTACT)		OPERATING HUMIDITY RANGE	RELATIVE HUMIDITY 85% max (NOT DEWED)			
SPECIFICATIONS								
ITEM		TEST METHOD		REQUIREMENTS		QT	AT	
CONSTRUCTION								
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.		x	x	
MARKING		CONFIRMED VISUALLY.				x	x	
ELECTRIC CHARACTERISTICS								
CONTACT RESISTANCE		100 mA(DC OR 1000Hz)		SIGNAL CONTACT : 90 mΩ MAX. MF CONTACT : 30 mΩ MAX.		x	—	
INSULATION RESISTANCE		250 V DC.		1000 MΩ MIN.		x	—	
VOLTAGE PROOF		300 V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.		x	—	
MECHANICAL CHARACTERISTICS								
INSERTION AND WITHDRAWAL FORCES		MEASURED BY APPLICABLE CONNECTOR.		INSERTION FORCE: 50 N MAX. WITHDRAWAL FORCE: 5 N MIN.		x	—	
MECHANICAL OPERATION		500 TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩ MAX. MF CONTACT : 40 mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.		x	—	
VIBRATION		FREQUENCY 10 TO 55 TO 10Hz, APPROX 5min SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.		x	—	
SHOCK		490 m/s <sup>2</sup> , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				x	—	
ENVIRONMENTAL CHARACTERISTICS								
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.		① CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩ MAX. MF CONTACT : 40 mΩ MAX.		x	—	
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 → +85 °C TIME 30 → 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)		② INSULATION RESISTANCE :1000 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.		x	—	
SULFUR DIOXIDE		EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)		NO HEAVY CORROSION.		x	—	
RESISTANCE TO SOLDERING HEAT		1)REFLOW SOLDERING : PEAK TMP : 260°C MAX REFLOW TMP: 220°C MIN FOR 60sec 2) SOLDERING IRONS : 360°C MAX. FOR 5 sec.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.		x	—	
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.		A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.		x	—	
	COUNT	DESCRIPTION OF REVISIONS		DESIGNED		CHECKED		DATE
△								
REMARKS <sup>(1)</sup> INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING. <sup>(2)</sup> *STORAGE* MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB. <sup>(3)</sup> THE RATED CURRENT APPLIES TO PER CONTACT.  Unless otherwise specified, refer to JIS-C-5402.				APPROVED	HS. OKAWA	11. 08. 30		
				CHECKED	KI. HIROKAWA	11. 08. 30		
				DESIGNED	TH. SANO	11. 08. 30		
				DRAWN	TH. SANO	11. 08. 30		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				DRAWING NO.		ELC4-334392-00		
HRS		SPECIFICATION SHEET		PART NO.		FX18-80S-0.8SV20		
		HIROSE ELECTRIC CO., LTD.		CODE NO.		CL579-0032-6-00		△ 1/1